

## Features

- 8-bit Multiplexed Addresses/Outputs
- Fast Read Access Time – 70 ns
- Dual Voltage Range Operation
  - Low-voltage Power Supply Range, 3.0V to 3.6V, or
  - Standard 5V  $\pm$  10% Supply Range
- Pin Compatible with Standard AT27C520
- Low-power CMOS Operation
  - 20  $\mu$ A Max Standby for ALE =  $V_{IH}$  and  $V_{CC} = 3.6V$
  - 29 mW Max Active at 5 MHz for  $V_{CC} = 3.6V$
- JEDEC Standard Packages
  - 20-lead TSSOP
  - 20-lead SOIC
- High-reliability CMOS Technology
  - 2,000V ESD Protection
  - 200 mA Latch-up Immunity
- Rapid Programming Algorithm – 50  $\mu$ s/Byte (Typical)
- CMOS- and TTL-compatible Inputs and Outputs
  - JEDEC Standard for LVTTTL
- Integrated Product Identification Code
- Industrial Temperature Range
- Green (Pb/Halide-free) Packaging Option

## 1. Description

The AT27LV520 is a low-power, high-performance, 524,288-bit one-time programmable read-only memory (OTP EPROM) organized 64K by eight bits. It incorporates latches for the eight lower order address bits to multiplex with the eight data bits. This minimizes system chip count, reduces cost, and simplifies the design of multiplexed bus systems. It requires only one power supply in the range of 3.0V to 3.6V for normal read mode operation, making it ideal for fast, portable systems using battery power. Any byte can be accessed in less than 70 ns.

The AT27LV520 is available in 20-lead TSSOP and 20-lead SOIC, one-time programmable (OTP) plastic packages.

Atmel's innovative design techniques provide fast speeds that rival 5V parts while keeping the low power consumption of a 3.3V supply. At  $V_{CC} = 3.0V$ , any byte can be accessed in less than 70 ns. With a typical power dissipation of only 18 mW at 5 MHz and  $V_{CC} = 3.3V$ , the AT27LV520 consumes less than one fifth the power of a standard 5V EPROM. Standby mode is achieved by asserting ALE high. Standby mode supply current is typically less than 1  $\mu$ A at 3.3V.

The AT27LV520 operating with  $V_{CC}$  at 3.0V produces TTL level outputs that are compatible with standard TTL logic devices operating at  $V_{CC} = 5.0V$ . The device is also capable of standard 5-volt operation making it ideally suited for dual supply range systems or card products that are pluggable in both 3-volt and 5-volt hosts.



**512K (64K x 8)  
Multiplexed  
Addresses/  
Outputs  
Low-voltage  
OTP EPROM**

**AT27LV520**

**Not Recommended  
for New Designs.**

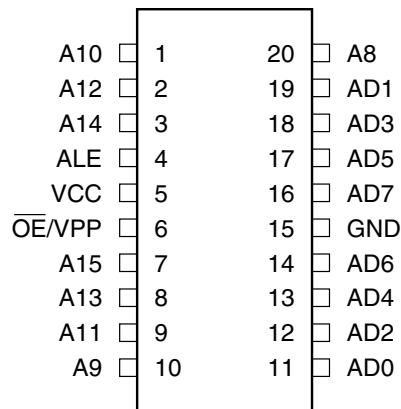


Atmel's AT27LV520 has additional features to ensure high quality and efficient production use. The Rapid Programming Algorithm reduces the time required to program the part and guarantees reliable programming. Programming time is typically only 50  $\mu$ s/byte. The Integrated Product Identification Code electronically identifies the device and manufacturer. This feature is used by industry-standard programming equipment to select the proper programming algorithms and voltages. The AT27LV520 programs exactly the same way as a standard 5V AT27C520 and uses the same programming equipment.

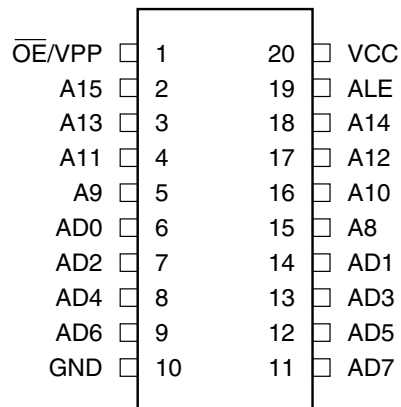
## 2. Pin Configurations

| Pin Name             | Function                     |
|----------------------|------------------------------|
| A8 - A15             | Addresses                    |
| AD0 - AD7            | Addresses/Outputs            |
| $\overline{OE}$ /VPP | Output Enable/Program Supply |
| ALE                  | Address Latch Enable         |

### 2.1 20-lead TSSOP Top View



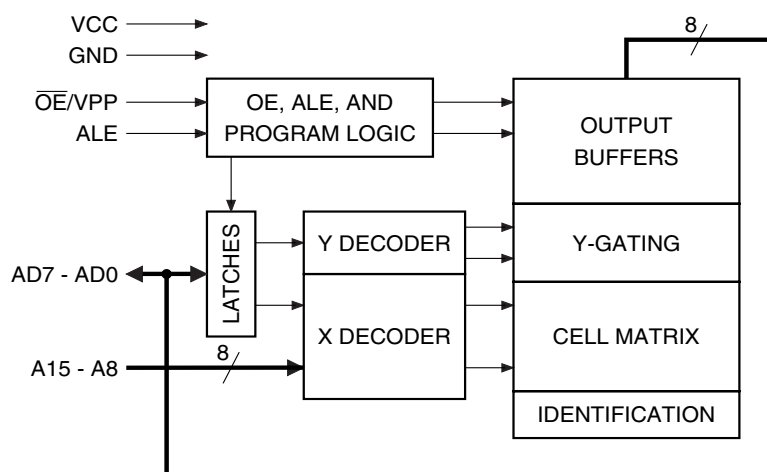
### 2.2 20-lead SOIC Top View



### 3. System Considerations

Switching under active conditions may produce transient voltage excursions. Unless accommodated by the system design, these transients may exceed datasheet limits, resulting in device non-conformance. At a minimum, a 0.1  $\mu\text{F}$  high frequency, low inherent inductance, ceramic capacitor should be utilized for each device. This capacitor should be connected between the  $V_{CC}$  and Ground terminals of the device, as close to the device as possible. Additionally, to stabilize the supply voltage level on printed circuit boards with large EPROM arrays, a 4.7  $\mu\text{F}$  bulk electrolytic capacitor should be utilized, again connected between the  $V_{CC}$  and Ground terminals. This capacitor should be positioned as close as possible to the point where the power supply is connected to the array.

### 4. Block Diagram



### 5. Absolute Maximum Ratings\*

|   |                                |
|---|--------------------------------|
| Temperature under Bias .....                            | -55°C to +125°C                |
| Storage Temperature .....                               | -65°C to +150°C                |
| Voltage on Any Pin with<br>Respect to Ground .....      | -2.0V to +7.0V <sup>(1)</sup>  |
| Voltage on A9 with<br>Respect to Ground .....           | -2.0V to +14.0V <sup>(1)</sup> |
| $V_{PP}$ Supply Voltage with<br>Respect to Ground ..... | -2.0V to +14.0V <sup>(1)</sup> |

\*NOTICE: Stresses beyond those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Note: 1. Minimum voltage is -0.6V DC which may undershoot to -2.0V for pulses of less than 20 ns. Maximum output pin voltage is  $V_{CC} + 0.75\text{V}$  DC which may overshoot to +7.0V for pulses of less than 20 ns.

## 6. Operating Modes

| Mode/Pin                              | ALE             | $\overline{OE}/V_{PP}$ | A8 - A15   | AD0 - AD7           |
|---------------------------------------|-----------------|------------------------|--|---------------------|
| Read <sup>(2)</sup>                   | $V_{IL}$        | $V_{IL}$               | Ai   | $D_{OUT}$           |
| Output Disable <sup>(2)</sup>         | $V_{IL}/V_{IH}$ | $V_{IH}$               | X <sup>(1)</sup>   | High Z/A0 - A7      |
| Standby                               | $V_{IH}$        | $V_{IH}$               | Ai   | A0 - A7             |
| Address Latch Enable <sup>(2)</sup>   | $V_{IH}$        | $V_{IH}$               | X  | A0 - A7             |
| Rapid Program <sup>(3)</sup>          | $V_{IH}$        | $V_{PP}$               | Ai   | $D_{IN}$            |
| Product Identification <sup>(4)</sup> | $V_{IL}$        | $V_{IL}$               | A9 = $V_H$ <sup>(5)</sup><br>A8 = $V_{IH}$ or $V_{IL}$<br>A10 - A15 = $V_{IL}$ | Identification Code |

- Notes:
- X can be  $V_{IL}$  or  $V_{IH}$ .
  - Read, output disable, and standby modes require  $3.0V \leq V_{CC} \leq 3.6V$ , or  $4.5V \leq V_{CC} \leq 5.5V$ .
  - Refer to Programming Characteristics.
  - $V_H = 12.0 \pm 0.5V$ .
  - Two identifier bytes may be selected. All A8 - A15 inputs are held low ( $V_{IL}$ ), except A9 which is set to  $V_H$  and A8 which is toggled low ( $V_{IL}$ ) to select the Manufacturer's Identification byte and high ( $V_{IH}$ ) to select the Device Code byte.

## 7. DC and AC Operating Conditions for Read Operation

|                                   | AT27LV520-70  | AT27LV520-90  |
|-----------------------------------|---------------|---------------|
| Industrial Operating Temp. (Case) | -40°C - +85°C | -40°C - +85°C |
| $V_{CC}$ Supply                   | 3.0V to 3.6V  | 3.0V to 3.6V  |
|                                   | 5V $\pm$ 10%  | 5V $\pm$ 10%  |

## 8. DC and Operating Characteristics for Read Operation

| Symbol   | Parameter                | Condition  | Min  | Max            | Units   |
|--|--------------------------|--|------|----------------|---------|
| <b><math>V_{CC} = 3.0V</math> to <math>3.6V</math></b> |                          |  |      |                |         |
| $I_{LI}$   | Input Load Current       | $V_{IN} = 0V$ to $V_{CC}$                                  |      | $\pm 1$        | $\mu A$ |
| $I_{LO}$   | Output Leakage Current   | $V_{OUT} = 0V$ to $V_{CC}$                                 |      | $\pm 5$        | $\mu A$ |
| $I_{SB}^{(1)}$   | $V_{CC}$ Standby Current | ALE = $V_{CC} \pm 0.3V$ ; Ai, ADi = GND/ $V_{CC} \pm 0.3V$ |      | 20             | $\mu A$ |
| $I_{CC}$   | $V_{CC}$ Active Current  | f = 5 MHz, $I_{OUT} = 0$ mA, ALE = $V_{IL}$                |      | 8              | mA      |
| $V_{IL}$   | Input Low Voltage        |  | -0.6 | 0.8            | V       |
| $V_{IH}$   | Input High Voltage       |  | 2.0  | $V_{CC} + 0.5$ | V       |
| $V_{OL}$   | Output Low Voltage       | $I_{OL} = 2.0$ mA  |      | 0.4            | V       |
| $V_{OH}$   | Output High Voltage      | $I_{OH} = -2.0$ mA   | 2.4  |                | V       |
| <b><math>V_{CC} = 4.5V</math> to <math>5.5V</math></b> |                          |  |      |                |         |
| $I_{LI}$   | Input Load Current       | $V_{IN} = 0V$ to $V_{CC}$                                  |      | $\pm 1$        | $\mu A$ |
| $I_{LO}$   | Output Leakage Current   | $V_{OUT} = 0V$ to $V_{CC}$                                 |      | $\pm 5$        | $\mu A$ |
| $I_{SB}^{(1)}$   | $V_{CC}$ Standby Current | ALE = $V_{CC} \pm 0.3V$ ; Ai, ADi = GND/ $V_{CC} \pm 0.3V$ |      | 100            | $\mu A$ |
| $I_{CC}$   | $V_{CC}$ Active Current  | f = 5 MHz, $I_{OUT} = 0$ mA, ALE = $V_{IL}$                |      | 20             | mA      |
| $V_{IL}$   | Input Low Voltage        |  | -0.6 | 0.8            | V       |
| $V_{IH}$   | Input High Voltage       |  | 2.0  | $V_{CC} + 0.5$ | V       |
| $V_{OL}$   | Output Low Voltage       | $I_{OL} = 2.1$ mA  |      | 0.4            | V       |
| $V_{OH}$   | Output High Voltage      | $I_{OH} = -400$ $\mu A$                                    | 2.4  |                | V       |

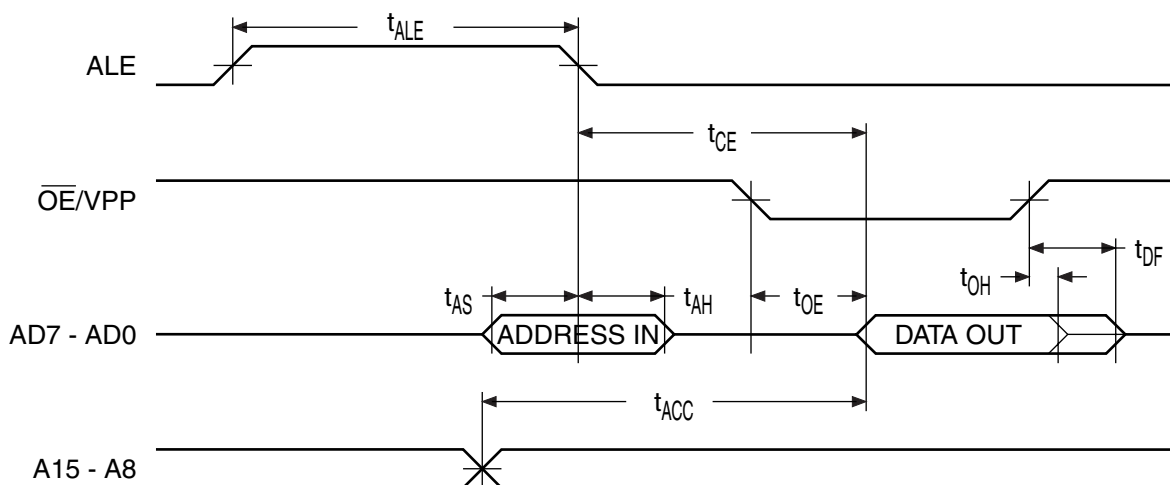
- Note: 1.  $V_{CC}$  standby current will be slightly higher with ALE, Ai, and ADi at TTL levels.

## 9. AC Characteristics for Read Operation

$V_{CC} = 3.0V$  to  $3.6V$  and  $4.5V$  to  $5.5V$

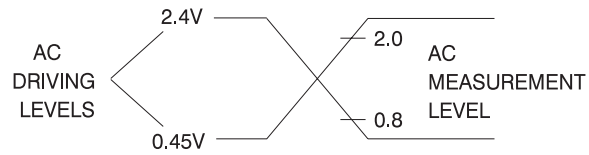
| Symbol            | Parameter   | Condition                             | AT27LV520-70 |     | AT27LV520-90 |     | Units |
|-------------------|---|---------------------------------------|--------------|-----|--------------|-----|-------|
|                   |   |                                       | Min          | Max | Min          | Max |       |
| $t_{ACC}^{(3)}$   | Address to Output Delay   | $ALE = \overline{OE}/V_{PP} = V_{IL}$ |              | 70  |              | 90  | ns    |
| $t_{CE}$          | Address Latch Enable Low to Output Delay                                    | Address Valid                         |              | 55  |              | 70  | ns    |
| $t_{AS}$          | Address Setup Time  | $\overline{OE}/V_{PP} = V_{IH}$       | 12           |     | 15           |     | ns    |
| $t_{AH}$          | Address Hold Time   | $\overline{OE}/V_{PP} = V_{IH}$       | 12           |     | 15           |     | ns    |
| $t_{ALE}$         | Address Latch Enable Width  | $\overline{OE}/V_{PP} = V_{IH}$       | 40           |     | 45           |     | ns    |
| $t_{OE}^{(3)}$    | $\overline{OE}/V_{PP}$ to Output Delay                                      | $ALE = V_{IL}$                        |              | 30  |              | 35  | ns    |
| $t_{DF}^{(4)(5)}$ | $\overline{OE}/V_{PP}$ High to Output Float                                 | $ALE = V_{IL}$                        |              | 25  |              | 25  | ns    |
| $t_{OH}$          | Output Hold from Address or $\overline{OE}/V_{PP}$ Whichever Occurred First | $ALE = V_{IL}$                        | 7            |     | 0            |     | ns    |

## 10. AC Waveforms for Read Operation<sup>(1)</sup>



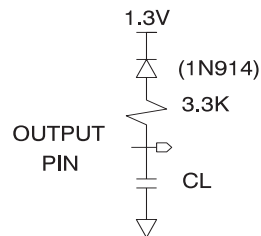
- Notes:
1. Timing measurement reference levels for all speed grades are  $V_{OL} = 0.8V$  and  $V_{OH} = 2.0V$ . Input AC drive levels are  $V_{IL} = 0.45V$  and  $V_{IH} = 2.4V$ .
  2.  $\overline{OE}/V_{PP}$  may be delayed up to  $t_{CE} - t_{OE}$  after the address is valid without impact on  $t_{CE}$ .
  3.  $\overline{OE}/V_{PP}$  may be delayed up to  $t_{ACC} - t_{OE}$  after the address is valid without impact on  $t_{ACC}$ .
  4. This parameter is only sampled and is not 100% tested.
  5. Output float is defined as the point when data is no longer driven.

## 11. Input Test Waveforms and Measurement Levels



$t_R, t_F < 20 \text{ ns (10\% to 90\%)}$

## 12. Output Test Load



Note:  $C_L = 100 \text{ pF}$  including jig capacitance.

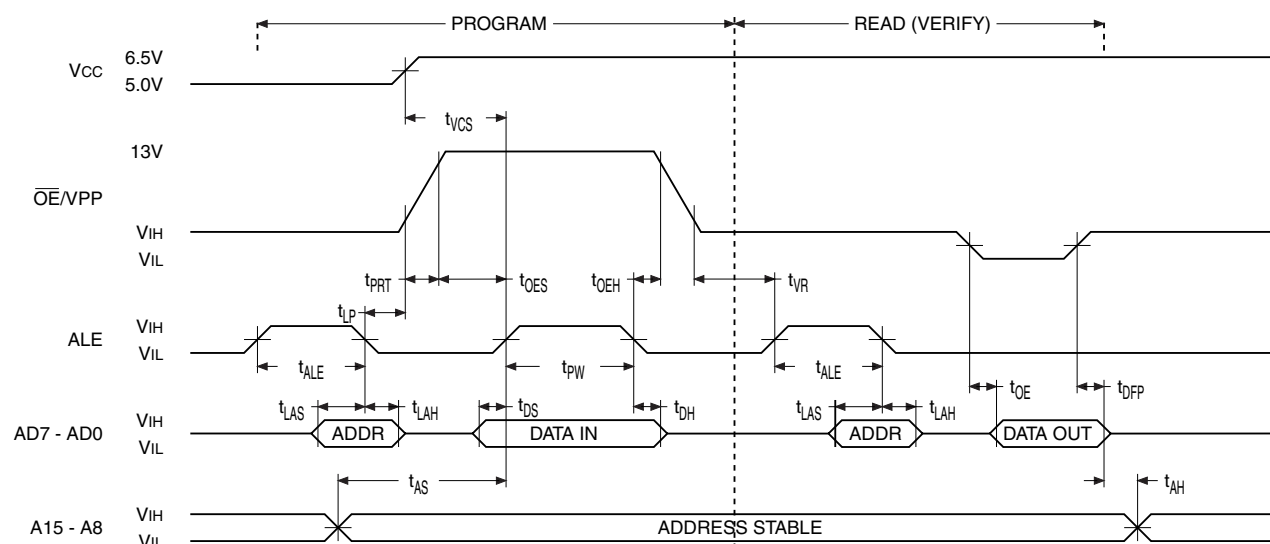
## 13. Pin Capacitance

$f = 1 \text{ MHz, } T = 25^\circ \text{ C}^{(1)}$

| Symbol    | Typ | Max | Units | Conditions     |
|-----------|-----|-----|-------|----------------|
| $C_{IN}$  | 4   | 6   | pF    | $V_{IN} = 0V$  |
| $C_{OUT}$ | 8   | 12  | pF    | $V_{OUT} = 0V$ |

Note: 1. Typical values for nominal supply voltage. This parameter is only sampled and is not 100% tested.

## 14. Programming Waveforms



- Notes:
1. The Input Timing Reference is 0.8V for  $V_{IL}$  and 2.0V for  $V_{IH}$ .
  2.  $t_{OE}$  and  $t_{DFF}$  are characteristics of the device but must be accommodated by the programmer.

## 15. DC Programming Characteristics

$T_A = 25 \pm 5^\circ C$ ,  $V_{CC} = 6.5 \pm 0.25V$ ,  $\overline{OE}/V_{PP} = 13.0 \pm 0.25V$

| Symbol    | Parameter                                    | Test Conditions           | Limits |                | Units   |
|-----------|--|---------------------------|--------|----------------|---------|
|           |  |                           | Min    | Max            |         |
| $I_{LI}$  | Input Load Current                           | $V_{IN} = V_{IL}, V_{IH}$ |        | $\pm 10$       | $\mu A$ |
| $V_{IL}$  | Input Low Level                              |                           | -0.6   | 0.8            | V       |
| $V_{IH}$  | Input High Level                             |                           | 2.0    | $V_{CC} + 1.0$ | V       |
| $V_{OL}$  | Output Low Voltage                           | $I_{OL} = 2.1 \text{ mA}$ |        | 0.4            | V       |
| $V_{OH}$  | Output High Voltage                          | $I_{OH} = -400 \mu A$     | 2.4    |                | V       |
| $I_{CC2}$ | $V_{CC}$ Supply Current (Program and Verify) |                           |        | 25             | mA      |
| $I_{PP2}$ | $\overline{OE}/V_{PP}$ Current               | $ALE = V_{IH}$            |        | 25             | mA      |

## 16. AC Programming Characteristics

$T_A = 25 \pm 5^\circ\text{C}$ ,  $V_{CC} = 6.5 \pm 0.25\text{V}$ ,  $\overline{\text{OE}}/V_{PP} = 13.0 \pm 0.25\text{V}$

| Symbol    | Parameter <sup>(1)</sup>  | Test Conditions   | Limits |               | Units         |
|-----------|---|---|--------|---------------|---------------|
|           |   |   | Min    | Max           |               |
| $t_{ALE}$ | Address Latch Enable Width  | Input Rise and Fall Times:<br>(10% to 90%) 20 ns<br><br>Input Pulse Levels:<br>0.45V to 2.4V<br><br>Input Timing Reference Level:<br>0.8V to 2.0V<br><br>Output Timing Reference Level:<br>0.8V to 2.0V | 500    |               | ns            |
| $t_{LAS}$ | Latched Address Setup Time  |   | 100    |               | ns            |
| $t_{LAH}$ | Latched Address Hold Time   |   | 100    |               | ns            |
| $t_{LP}$  | ALE Low to $\overline{\text{OE}}/V_{PP}$ High Voltage Delay             |   | 2      |               | $\mu\text{s}$ |
| $t_{OES}$ | $\overline{\text{OE}}/V_{PP}$ Setup Time                                |   | 2      |               | $\mu\text{s}$ |
| $t_{OEH}$ | $\overline{\text{OE}}/V_{PP}$ Hold Time                                 |   | 2      |               | $\mu\text{s}$ |
| $t_{DS}$  | Data Setup Time   |   | 2      |               | $\mu\text{s}$ |
| $t_{DH}$  | Data Hold Time  |   | 2      |               | $\mu\text{s}$ |
| $t_{PW}$  | ALE Program Pulse Width <sup>(2)</sup>                                  |   | 47.5   | 52.5          | $\mu\text{s}$ |
| $t_{VR}$  | $\overline{\text{OE}}/V_{PP}$ Recovery Time                             |   | 2      |               | $\mu\text{s}$ |
| $t_{VCS}$ | $V_{CC}$ Setup Time   |   | 2      |               | $\mu\text{s}$ |
| $t_{OE}$  | Data Valid from $\overline{\text{OE}}/V_{PP}$                           |   |        | 150           | ns            |
| $t_{DFP}$ | $\overline{\text{OE}}/V_{PP}$ High to Output Float Delay <sup>(3)</sup> |   | 0      | 130           | ns            |
| $t_{AS}$  | Address Setup Time  |   | 2      |               | $\mu\text{s}$ |
| $t_{AH}$  | Address Hold Time   | 0   |        | $\mu\text{s}$ |               |
| $t_{PRT}$ | $\overline{\text{OE}}/V_{PP}$ Pulse Rise Time During Programming        | 50  |        | ns            |               |

- Notes:
- $V_{CC}$  must be applied simultaneously or before  $\overline{\text{OE}}/V_{PP}$  and removed simultaneously or after  $\overline{\text{OE}}/V_{PP}$ .
  - Program Pulse width tolerance is  $50 \mu\text{sec} \pm 5\%$ .
  - This parameter is only sampled and is not 100% tested. Output Float is defined as the point where data is no longer driven – see timing diagram.

## 17. Atmel's AT27LV520 Integrated Product Identification Code

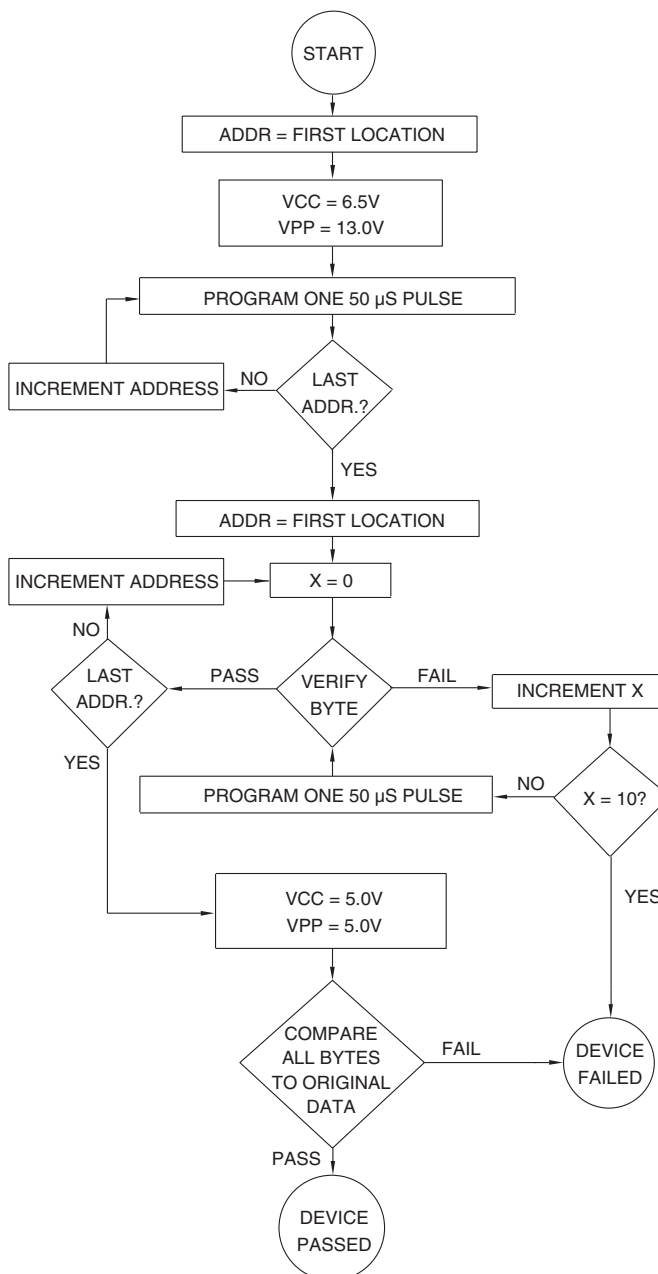
| Codes        | Pins |     |     |     |     |     |     |     |     | Hex Data |
|--------------|------|-----|-----|-----|-----|-----|-----|-----|-----|----------|
|              | A8   | AD7 | AD6 | AD5 | AD4 | AD3 | AD2 | AD1 | AD0 |          |
| Manufacturer | 0    | 0   | 0   | 0   | 1   | 1   | 1   | 1   | 0   | 1E       |
| Device Type  | 1    | 1   | 0   | 0   | 1   | 1   | 1   | 0   | 1   | 9D       |

- Note: 1. The AT27LV520 has the same product identification code as the AT27C520. Both are programming compatible.



## 18. Rapid Programming Algorithm

A 50  $\mu$ s ALE pulse width is used to program. The address is set to the first location.  $V_{CC}$  is raised to 6.5V and  $\overline{OE}/V_{PP}$  is raised to 13.0V. Each address is first programmed with one 50  $\mu$ s ALE pulse without verification. Then a verification/reprogramming loop is executed for each address. In the event a byte fails to pass verification, up to 10 successive 50  $\mu$ s pulses are applied with a verification after each pulse. If the byte fails to verify after 10 pulses have been applied, the part is considered failed. After the byte verifies properly, the next address is selected until all have been checked.  $\overline{OE}/V_{PP}$  is then lowered to  $V_{IH}$  and  $V_{CC}$  to 5.0V. All bytes are read again and compared with the original data to determine if the device passes or fails.





## 19. Ordering Information

### 19.1 Standard Package

| $t_{ACC}$ (ns) | $I_{CC}$ (mA)<br>Active | Ordering Code  | Package | Operation Range                |
|----------------|-------------------------|----------------|---------|--------------------------------|
| 70             | 8                       | AT27LV520-70SI | 20S     | Industrial<br>(-40°C to +85°C) |
|                |                         | AT27LV520-70XI | 20X     |                                |
| 90             | 8                       | AT27LV520-90SI | 20S     | Industrial<br>(-40°C to +85°C) |
|                |                         | AT27LV520-90XI | 20X     |                                |

### 19.2 Green Package (Pb/Halide-free)

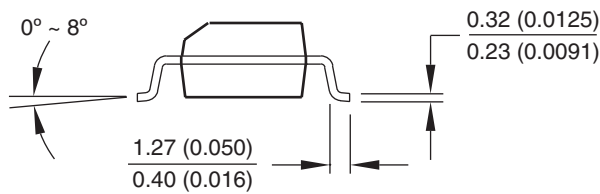
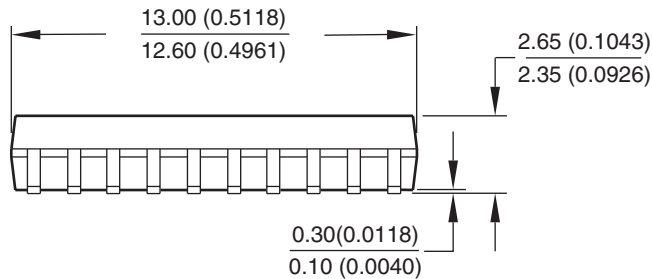
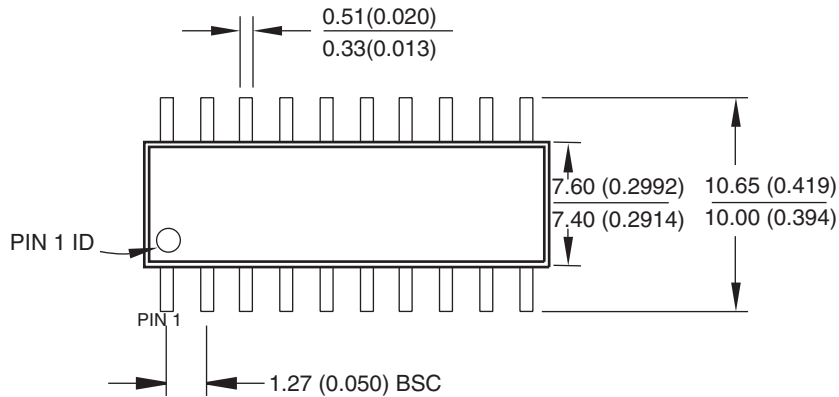
| $t_{ACC}$ (ns) | $I_{CC}$ (mA)<br>Active | Ordering Code  | Package | Operation Range                |
|----------------|-------------------------|----------------|---------|--------------------------------|
| 70             | 8                       | AT27LV520-70SU | 20S     | Industrial<br>(-40°C to +85°C) |
|                |                         | AT27LV520-70XU | 20X     |                                |
| 90             | 8                       | AT27LV520-90XU | 20X     | Industrial<br>(-40°C to +85°C) |

| Package Type |   |
|--------------|---|
| <b>20S</b>   | 20-lead, 0.300" Wide, Plastic Gull Wing Small Outline (SOIC)          |
| <b>20X</b>   | 20-lead, 4.4 mm Body Width, Plastic Thin Shrink Small Outline (TSSOP) |

20. Packaging Information

20.1 20S – SOIC

Dimensions in Millimeters and (Inches).  
 Controlling dimension: Inches.  
 JEDEC Standard MS-013



10/23/03

**ATMEL** 2325 Orchard Parkway  
 San Jose, CA 95131

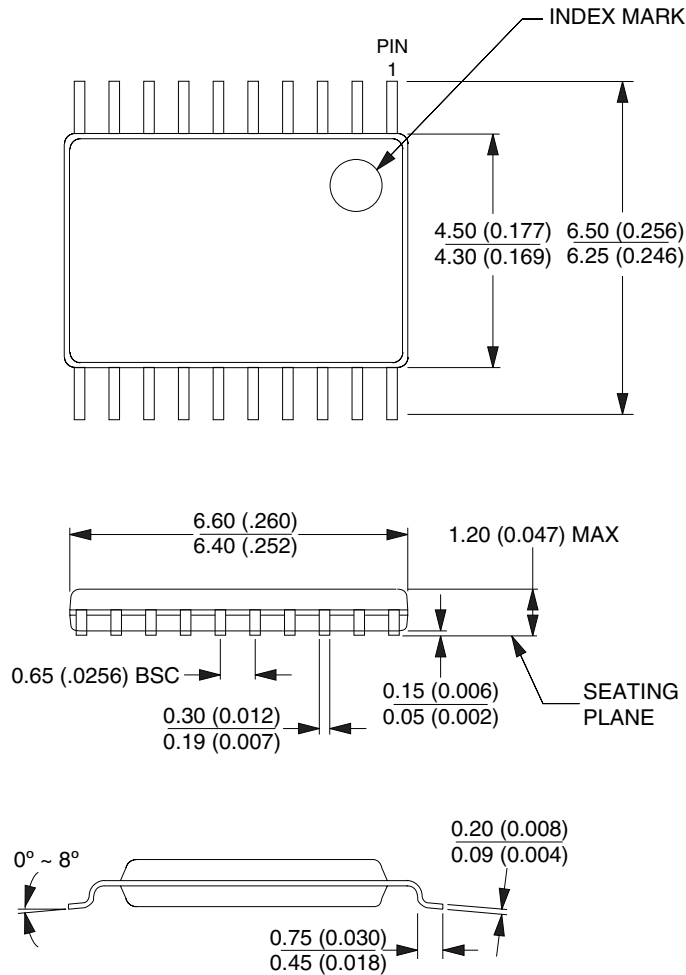
**TITLE**  
**20S, 20-lead, 0.300" Body, Plastic Gull Wing Small Outline (SOIC)**

**DRAWING NO.**  
 20S

**REV.**  
 B

## 20.2 20X – TSSOP

Dimensions in Millimeters and (Inches).  
 Controlling dimension: Millimeters.  
 JEDEC Standard MO-153 AC



10/23/03



2325 Orchard Parkway  
 San Jose, CA 95131

**TITLE**

**20X**, (Formerly 20T), 20-lead, 4.4 mm Body Width,  
 Plastic Thin Shrink Small Outline Package (TSSOP)

**DRAWING NO.**

20X

**REV.**

C



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